TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74AC139FN

Dual 2-to-4 Line Decoder

The TC74AC139 is an advanced high speed CMOS 2-to-4 LINE DECODER fabricated with silicon gate and double-layer metal wiring C^2MOS technology.

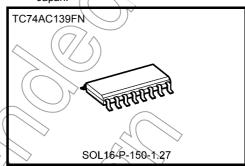
It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The active low enable input can be used for gating or it can be used as a data input for demultiplexing applications.

When the enable input is held "H", all four outputs are fixed at a high logic level independent of the other inputs.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.





Weight

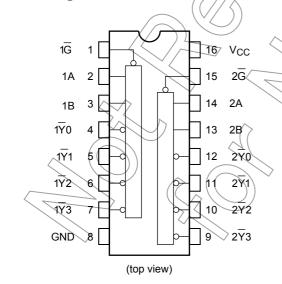
SOL16-P-150-1,27

);⁾0.13 g (typ.)

Features

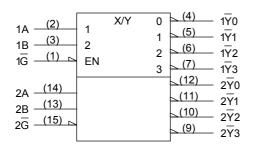
- High speed: $t_{pd} = 5.9 \text{ ns}$ (typ.) at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 8 \mu A \text{ (max)}$ at $T_a = 25^{\circ}C$
- High noise immunity: V_{NIH} = V_{NIL} = 28% V_{CC} (min)
- Symmetrical output impedance: $|I_{OH}| = I_{OL} = 24 \text{ mA (min) Capability of driving 50 } \Omega \text{ transmission lines}.$
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: V_{CC} (opr) $\neq 2$ V to 5.5 V
- Pin and function compatible with 74F139

Pin Assignment



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IEC Logic Symbol



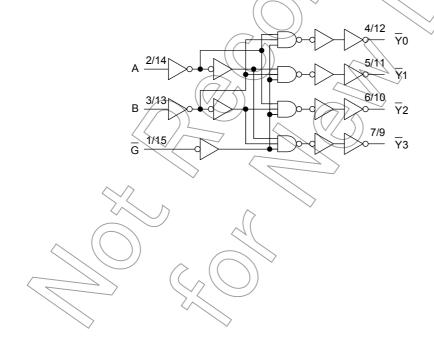
1A —(2) 1B —(3) 1G —(1) —	$ \begin{array}{c} DMUX \\ 0 \\ 1 \end{array} $	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$
2A — (14) 2B — (13) 2G — (15) —		$ \begin{array}{cccc} (12) & 2\overline{y}0 \\ (11) & 2\overline{y}1 \\ (10) & 2\overline{y}2 \\ \underline{y}2 & 2\overline{y}3 \end{array} $

Truth Table

Inp	uts			Out	0-141		
Enable	Sel	ect	_ Y0	<u></u>		- 73	Selected Output
G	В	Α	10	11	12	13	. <
Н	Х	Х	Н	Н	Н	Н	None
L	L	L	L	Н	Н	Н	<u>Y</u> 0
L	L	Н	Н	L	Н	Н	\(\bar{Y}1\)
L	Н	L	Н	Н	L	Н	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
L	Н	Н	Н	Н	Н	L	<u>7</u> 3

X: Don't care

System Diagram



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Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CC}	−0.5 to 7.0	V
DC input voltage	V _{IN}	-0.5 to V _{CC} + 0.5	V
DC output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5	٧
Input diode current	I _{IK}	±20	mA
Output diode current	lok	±50	mA
DC output current	lout	±50	mA
DC V _{CC} /ground current	Icc	±200)) mA
Power dissipation	PD	180	mW
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	Vec	2.0 to 5.5	V
Input voltage	((VIN))	0 to Vcc	V
Output voltage	Vout	0 to VCC	V
Operating temperature	Topr	=40 to 85	°C
Input rise and fall time	dt/dV <	$0.00 (V_{CC} = 3.3 \pm 0.3 \text{ V})$ $0.40 \pm 20 (V_{CC} = 5 \pm 0.5 \text{ V})$	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device.
Unused inputs must be tied to either VCC or GND.

Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition		_	Ta = 25°C			Ta = -40 to 85°C		Unit
Characteristics	Зуптьог				Min	Тур.	Max	Min	Max	Offic
				2.0	1.50	_ <	/_	1.50	_	
High-level input voltage	V_{IH}		_	3.0	2.10	_	(2.10	_	V
				5.5	3.85	_	1	3.85	_	
L and land bank				2.0	_	(0	0.50	_	0.50	
Low-level input voltage	V_{IL}		_	3.0		\ \ \	_0.90	_	0.90	V
				5.5	-(7	1.65	_	1.65	
				2.0	1.9	2.0	_	1.9	_	
		VIN = VIH or VIL	I _{OH} = -50 μA	3.0	2.9	3.0	_	2.9	_	
High-level output	VoH			4.5	4.4	4.5		4.4	\rightarrow	V
voltage	- 011		$I_{OH} = -4 \text{ mA}$	(3.0)	2.58	_	-6	2.48	> -	v
			I _{OH} = −24 mA	4.5	3.94	-\	7	3.80) —	
			$I_{OH} = -75 \text{ mA}$ (Note)	5.5	_	_		3.85/		
		V _{IN} = V _{IH} or		2.0	_	0.0	0.1		0.1	
			I _{OL} = 50 μA	3.0	_	0.0	0,1	_	0.1	
Low-level output	V _{OL}			4.5	_	(0.0)	0.1	_	0.1	V
voltage	OL	V _{IL}	I _{OL} = 12 mA	3.0			0.36	_	0.44	-
			I _{OL} = 24 mA	4.5	-	_	0.36	_	0.44	
			$I_{OL} = 75 \text{ mA}$ (Note)	5.5	_))—	_	_	1.65	
Input leakage current	I _{IN}	V _{IN} = V _C	C or GND	5.5		-	±0.1	_	±1.0	μΑ
Quiescent supply current	Icc	VIN \(\frac{1}{2}\)	C of GND	5.5	_	_	8.0	_	80.0	μΑ

Note: This spec indicates the capability of driving 50 Ω transmission lines.

One output should be tested at a time for a 10 ms maximum duration.

AC Characteristics ($C_L = 50 \text{ pF}, R_L = 500 \Omega$, input: $t_r = t_f = 3 \text{ ns}$)

Characteristics Symbo		Test Condition		Ta = 25°C			Ta = −40 to 85°C		Unit
		$\langle \rangle$	V _{CC} (V)	Min	Тур.	Max	Min	Max	
Propagation delay time	t _{pLH}	4(_	3.3 ± 0.3	_	8.2	13.9	1.0	16.0	ns
(A, B- Y)	t _{pHL}		5.0 ± 0.5	_	6.2	9.0	1.0	10.3	110
Propagation delay time	t _{pLH}		3.3 ± 0.3	_	7.6	12.9	1.0	14.8	ns
$(\overline{G} - \overline{Y})$	t _{pHL}		5.0 ± 0.5	1	5.8	8.5	1.0	9.6	110
Input capacitance	C _{IN}			-	5	10	_	10	pF
Power dissipation capacitance	C _{PD}		(Note)		110			_	pF

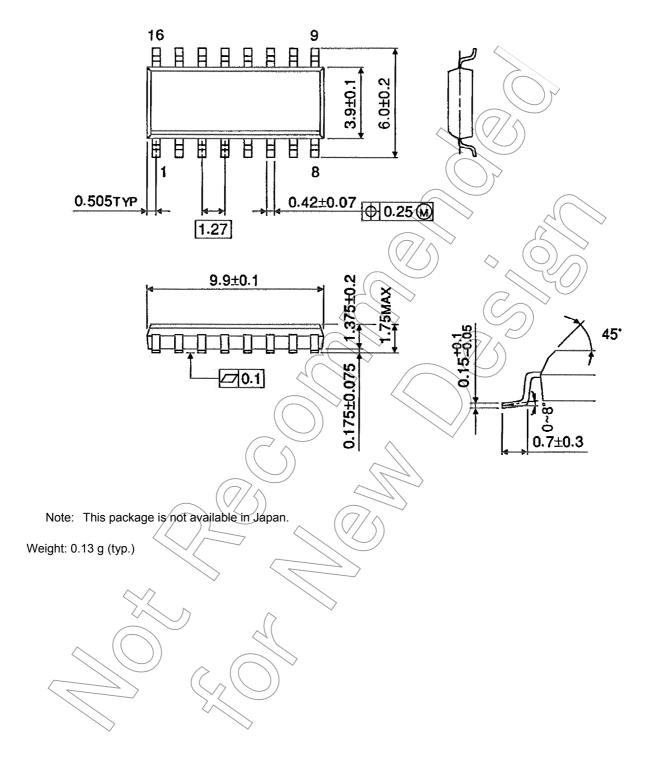
Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2 \text{ (per decoder)}$

Package Dimensions (Note)

SOL16-P-150-1.27 Unit: mm



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